



materials



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Feature Paper in Section Smart Materials

Guest Editor:

Prof. Dr. Seung Hwan Ko

Mechanical Engineering, Seoul
National University, Seoul,
Republic of Korea

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Message from the Guest Editor

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The Special Issue “**Feature Paper in Section Smart Materials**” will present a collection of high-quality original research papers and comprehensive reviews on the recent advances in the field of functional and smart materials for energy devices, electronics, soft robotics, sensors, and actuators. This Special Issue intends to highlight new knowledge and the latest innovative approaches and developments in all aspects of the synthesis, processing, characterization, and performance of functional and smart materials and their integration in existing and emerging applications. The potential topics include, but are not limited to:

- Energy generation devices
- Energy storage devices
- Sensors
- Actuators
- Flexible electronics
- Stretchable electronics
- Wearable electronics
- Soft robotics
- Biomechanics
- Display

Prof. Dr. Seung Hwan Ko
Guest Editor



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Special Issue



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Editor-in-Chief

Prof. Dr. Maryam Tabrizian

1. Department of Biomedical Engineering, Faculty of Medicine and Health Sciences, McGill University, Montreal, QC H3A 2B6, Canada

2. Faculty of Dentistry and Oral Health Sciences, McGill University, 3640 Rue University, Montreal, QC H3A 0C7, Canada

Message from the Editor-in-Chief

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Materials Editorial Office
MDPI, St. Alban-Anlage 66
4052 Basel, Switzerland

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